P/N: FASDRH1206B-150M4R6

RoHS

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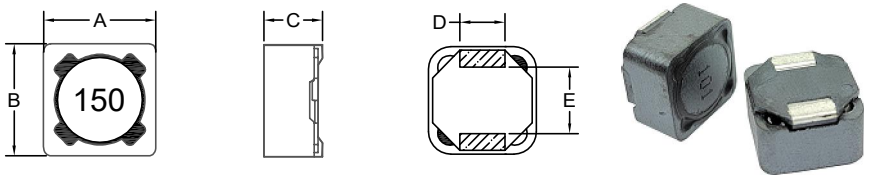
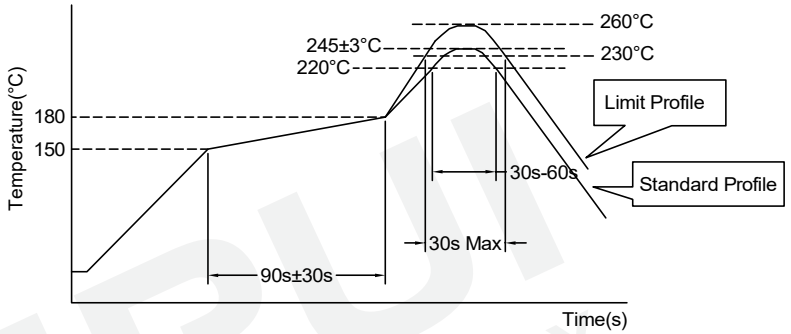
Outline Dimensions(Unit:mm)



Top view　　Side view　　Bottom view

A	B	C	D	E
Max	Max	Max	REF	REF
12.80	12.80	6.50	5.00	6.00

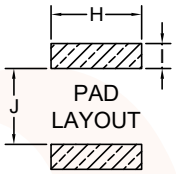
Recommended Soldering Temperature Graph.



	Standard Profile	Standard Profile
Pre-heating	150~180°C,90s±30s	
Heating	above 220°C,30s-60s	above 240°C,30s Max
Peak temperature	245°C±3°C	260°C,10s
Cycle of reflow	2 times	2 times

Electronical Schematic

Suggested Pad layout



H	5.40 REF
I	2.90 REF
J	5.80 REF

Electrical Characteristics(@25°C)

Inductance 100KHz,0.1V	DC Resistance	Isat A Max	Irms (A)△T≤40°C	Q Typ 2.52MHz	SRF Typ
15.0uH±20%	23.00mΩ Max	L(5.00A)≥70%*L0A	5.20A Max	27	19.4MHz

General Specifications

*Operating Temperature: -40°C~+125°C
(Temperature rise included)
*Storage Temperature: -40°C~+125°C
*Resistance to Soldering Heat: +260°C for 10 Sec
*Storage Humidity:RH10%~70%.

Applications

*Input/output of DC/DC converters
*Power supplies for:
-Portable communication equipment
-Camcorders
-LCD televisions
-Car radios

REV	DESCRIPTION	APPD	DATE

Tianchang Fuan Electronic Co Ltd
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TEL: +86-550-7814888
FAX:+86-550-7831133

Tolerances unless otherwise specified:
(.X)±0.50　(.XX)±0.25
Unit of measurement: mm

Make: Qiumei.Liu
Checked: Beson. zhan
Approved: Anson. zhan

DRAWING TITLE
SHIELDED SMD
POWER INDUCTORS

Material Number:

Customer Name:
Document/Rev: 2211016/00
Specification Sheet: 1 of 4
Date of Recognition: Nov./01/2022

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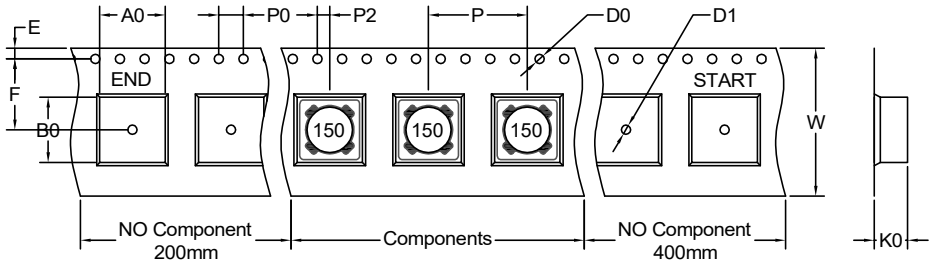
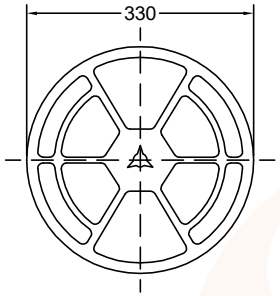
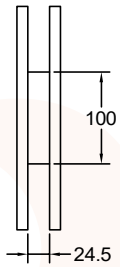
Packing Specfications(Unit:mm):

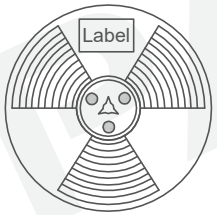


A0	12.6	F	11.5
B0	12.8	D0	1.50
P	16.0	D1	1.50
P0	4.00	K0	7.25
P2	2.00	W	24.0
E	1.75		

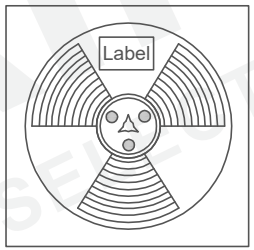


Quantity:600pcs/Reel

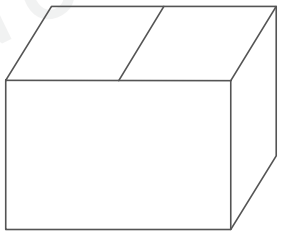




Quantity:600pcs



Inner box
Quantity: 1800 pcs/box



Outer cases: 3600pcs/box
Insufficient boxes filled with inner boxes or fillers

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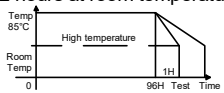
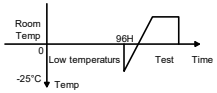
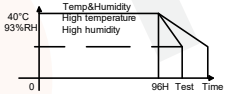
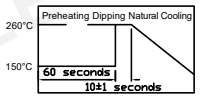
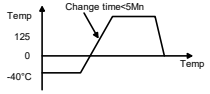
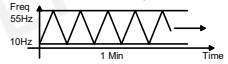
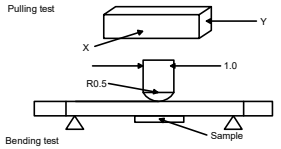
Reliability Testing:

Ltem	Specified value	Test methods
High temperature Storage test Reference documents: MIL-STD-202G Method 108A	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	Temperature:85±2°C Time:96±2 hours. Tested not less than 1 hour, not more than 2 hours at room temperature. 
Low temperature Storage test. Referencedocuments: IEC 68-2-1A 6.1 6.2	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	Temperature:25±2°C Time:96±2 hours. Tested not less than 1 hour, not more than 2 hours at room temperature. 
Humidity test Reference Documents: MIL-STD-202G Method 103B	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	1.Dry oven at a temperature of 40°±5°C for 24 hours. 2.Measurements At the end of this period 3.Exposure:Temperature:40±2°C,Humidity: 93±3%RH Time:96±2 hours. 4.Tested while the specimens are still in the chamber. 5.Tested not less than 1 hour, nor more than 2 hours at room temperature. 
Heat endurance of Reflow soldering	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	Preheat:150°C,60 second. Solder:Sn/Ag/Cu. Solder:Temperature:260±5°C. Flux:Rosin flux. Reflow peak time 10 second at 260°C 

Ltem	Specified value	Test methods
Thermal shock test Reference documents: MIL-STD-202G Method 107G	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. For T:weighe≤28g:15 Min 28g≤weight≤136g:30 Min	First-40°C for T time,next+125°C Ttime as 1 cycle. Go through 20 cycles. 
Solderability test Reference documents: MIL-STD-202G Method 208H IPC J-STD-002B	Terminals area must have 95% Min. Solder coverage.	Dip pads in flux then dip in solder pot at 245±5°C for 5 second. Soler:Sn(93.5)Ag(3.5). Flux:Rosin flux.
Vibration test Reference documents: MIL-STD-202G Method 201A	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	Apply frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours.(total 6 hours). 
Drop test Reference documents: MIL-STD-202G Method 203G	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. For T:weighe≤28g:15 Min 28g≤weight≤136g:30 Min	Packaged & Drop down from 1m with 981m/s2(100G)attitude in 1 angle 1 ridges & 2 surfaces orientations.
Terminal strength push test Reference documents: JIS C 5321:1997	Pulling test: DEFINE:A:sectional area of terminal A≤8(Sq M) Force≥5N time:30sec 8(Sq M)<A≤20(Sq M) Force≥10N time:10sec 20(Sq M)<A force≥20N time:10sec Bending test: Soldering the products on PCB,after the pulling testand bending test, terminal should not pull off	Bend the testing PCB at middle point, the deflection shall be 2mm 

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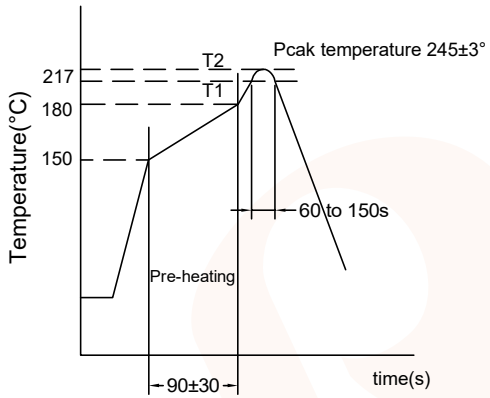
Ltem	Specified value	Test methods
Resistance to solvent test Reference documents: IEC 68-2-45:1993	No case deformation or change in appearance,or obliteration of marking	To dip parts into IPA solvent for 5±0.5Min, then drying them atroom temp for 5 Min,at last,to brushing making 10 times.
Electronic characteristic test of major products	Refer to catalogue of specific products	Refer to catalogue of specific products
Overload test Reference documents:	1.During the test no smoke,no peculiar,smell, no fire	Apply twice as rated current for 5 minutes.

Recommended solderability temperature profile:



Use rosin-based flux
Don't use high acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).
Use lead-free solder, use Sn-3.0Ag-0.5Cu solder
Standard thickness of solder paste:0.12-0.15mm

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